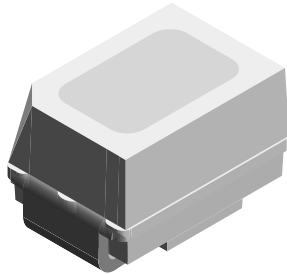


Low Current Mini SMD LED



19226

DESCRIPTION

The new low current MiniLED Series have been designed in a small white SMT package. The feature of the device is the very small package 2.3 mm x 1.3 mm x 1.4 mm and the low forward current. The MiniLED is an obvious solution for small-scale, high-power products that are expected to work reliably in an arduous environment. This is often the case in automotive and industrial application.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD MiniLED
- Product series: low current
- Angle of half intensity: $\pm 60^\circ$

FEATURES

- SMD LED with exceptional brightness
- Luminous intensity categorized
- Compatible with automatic placement equipment
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- IR reflow soldering according to J-STD-020
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin.} \leq 1.6$
- Preconditioning according to JEDEC® level 2a
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches, and symbols

PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at I _F (mA)	WAVELENGTH (nm)			at I _F (mA)	FORWARD VOLTAGE (V)			at I _F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMS2000-GS08	Super red	2.24	4.5	-	2	-	630	-	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMS20H2K1-GS08	Super red	3.55	-	9	2	-	630	-	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMS20H2L1-GS08	Super red	3.55	-	14	2	-	630	-	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMS20J2L1-GS08	Super red	5.6	-	14	2	-	630	-	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMK20J2L2-GS08	Amber	5.6	-	18	2	612	622	624	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMK2000-GS08	Amber	7.1	16	-	2	612	622	624	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMK20K1L2-GS08	Amber	7.1	-	18	2	612	622	624	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMO20J2M1-GS08	Soft orange	5.6	-	22.4	2	598	605	611	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMO20K2L2-35-GS08	Soft orange	9	-	18	2	602	-	609	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMY2000-GS08	Yellow	3.55	7.1	-	2	581	588	594	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMY20J1L2-GS08	Yellow	4.5	-	18	2	581	588	594	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMY20K1L2-GS08	Yellow	7.1	-	18	2	581	588	594	2	-	1.8	2.2	2	AllnGaP on GaAs
VLMP20D2G1-GS08	Pure green	0.56	-	2.24	2	555	-	565	2	-	1.8	2.2	2	AllnGaP on GaAs



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) VLMS20.., VLMS20.., VLMO20.., VLMS20.., VLMS20..				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ⁽¹⁾		V_R	5	V
DC forward current	$T_{amb} \leq 100\text{ }^{\circ}\text{C}$	I_F	15	mA
Surge forward current	$t_p \leq 10\text{ }\mu\text{s}$	I_{FSM}	0.1	A
Power dissipation		P_V	40	mW
Junction temperature		T_j	+125	$^{\circ}\text{C}$
Operating temperature range		T_{amb}	-40 to +100	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +100	$^{\circ}\text{C}$
Thermal resistance junction/ambient	Mounted on PC board (pad size > 5 mm ²)	R_{thJA}	580	K/W

Note

⁽¹⁾ Driving the LED in reverse direction is suitable for a short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) VLMS20.., SUPER RED							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ⁽¹⁾	$I_F = 2\text{ mA}$	VLMS2000	I_V	2.24	4.5	-	mcd
		VLMS20H2K1	I_V	3.55	-	9	mcd
		VLMS20H2L1	I_V	3.55	-	14	mcd
		VLMS20J2L1	I_V	5.6	-	14	mcd
Dominant wavelength	$I_F = 2\text{ mA}$		λ_d	-	630	-	nm
Peak wavelength	$I_F = 2\text{ mA}$		λ_p	-	643	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$		ϕ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$		V_F	-	1.8	2.2	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5	-	-	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_j	-	15	-	pF

Note

⁽¹⁾ In one packing unit $I_{Vmax}/I_{Vmin} \leq 1.6$

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) VLMK20.., AMBER							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ⁽¹⁾	$I_F = 2\text{ mA}$	VLMK20J2L2	I_V	5.6	-	18	mcd
		VLMK2000	I_V	7.1	16	-	mcd
		VLMK20K1L2	I_V	7.1	-	18	mcd
Dominant wavelength	$I_F = 2\text{ mA}$		λ_d	612	622	624	nm
Peak wavelength	$I_F = 2\text{ mA}$		λ_p	-	615	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$		ϕ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$		V_F	-	1.8	2.2	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5	-	-	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_j	-	15	-	pF

Note

⁽¹⁾ In one packing unit $I_{Vmax}/I_{Vmin} \leq 1.6$



OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
VLMO20.., SOFT ORANGE							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ⁽¹⁾	$I_F = 2\text{ mA}$	VLMO20J2M1	I_V	5.6	-	22.4	mcd
		VLMO20K2L2-35	I_V	9	-	18	mcd
Dominant wavelength	$I_F = 2\text{ mA}$	VLMO20K2L2-35	λ_d	602	-	609	nm
		VLMO20..	λ_d	598	605	611	nm
Peak wavelength	$I_F = 2\text{ mA}$		λ_p	-	610	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$		ϕ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$		V_F	-	1.8	2.2	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5	-	-	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_j	-	15	-	pF

Note

⁽¹⁾ In one packing unit $I_{Vmax}/I_{Vmin.} \leq 1.6$

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
VLMY20.., YELLOW							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ⁽¹⁾	$I_F = 2\text{ mA}$	VLMY2000	I_V	3.55	7.1	-	mcd
		VLMY20J1L2	I_V	4.5	-	18	mcd
		VLMY20K1L2	I_V	7.1	-	18	mcd
Dominant wavelength	$I_F = 2\text{ mA}$		λ_d	581	588	594	nm
Peak wavelength	$I_F = 2\text{ mA}$		λ_p	-	590	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$		ϕ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$		V_F	-	1.8	2.2	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5	-	-	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_j	-	15	-	pF

Note

⁽¹⁾ In one packing unit $I_{Vmax}/I_{Vmin.} \leq 1.6$

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
VLMP20.., PURE GREEN							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ⁽¹⁾	$I_F = 2\text{ mA}$	VLMP20D2G1	I_V	0.56	-	2.24	mcd
Dominant wavelength	$I_F = 2\text{ mA}$		λ_d	555	-	565	nm
Peak wavelength	$I_F = 2\text{ mA}$		λ_p	-	565	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$		ϕ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$		V_F	-	1.8	2.2	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5	-	-	V
Junction capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_j	-	15	-	pF

Note

⁽¹⁾ In one packing unit $I_{Vmax}/I_{Vmin.} \leq 1.6$

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)



Fig. 1 - Forward Current vs. Ambient Temperature

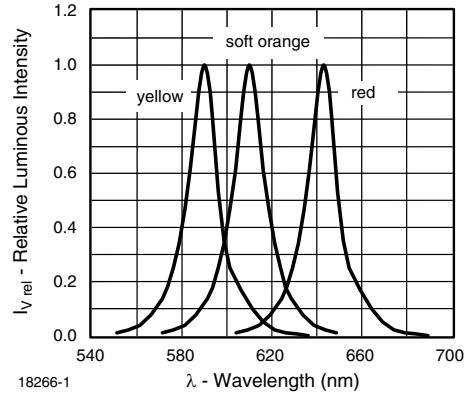


Fig. 4 - Relative Intensity vs. Wavelength

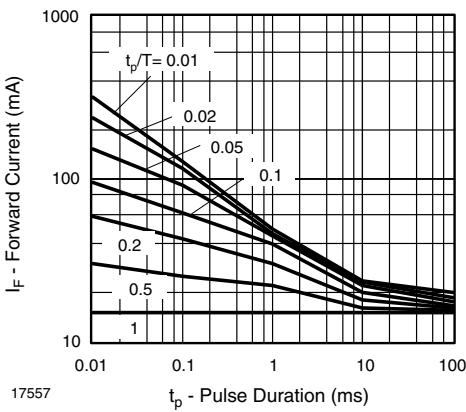


Fig. 2 - Forward Current vs. Pulse Length

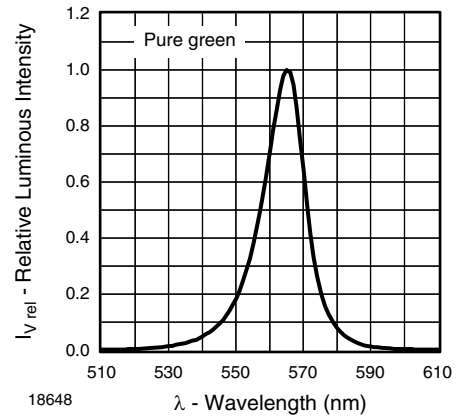


Fig. 5 - Relative Luminous Intensity vs. Wavelength

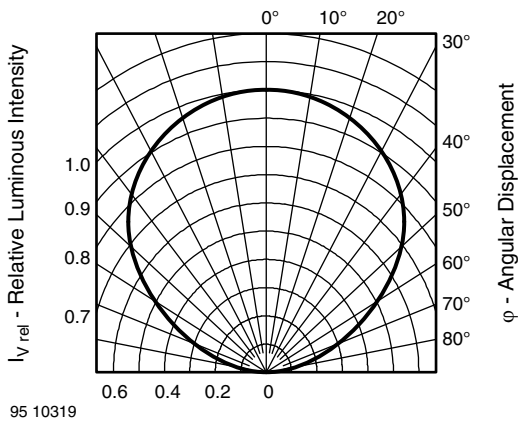


Fig. 3 - Relative Luminous Intensity vs. Angular Displacement

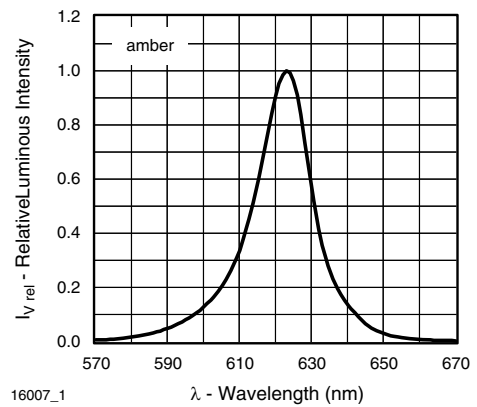


Fig. 6 - Relative Luminous Intensity vs. Wavelength



Fig. 7 - Forward Current vs. Forward Voltage



Fig. 10 - Forward Voltage vs. Ambient Temperature



Fig. 8 - Relative Luminous Intensity vs. Ambient Temperature



Fig. 11 - Change of Forward Voltage vs. Ambient Temperature

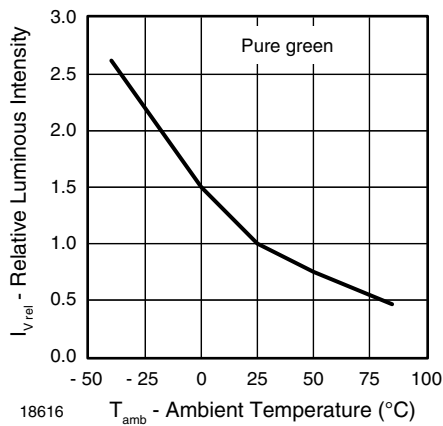


Fig. 9 - Relative Luminous Intensity vs. Ambient Temperature



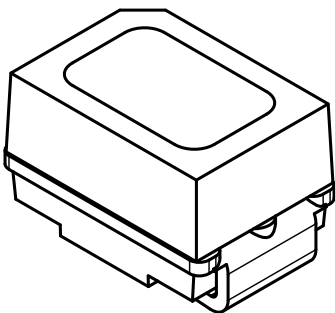
PACKAGE DIMENSIONS in millimeters



Not indicated tolerances ± 0.2



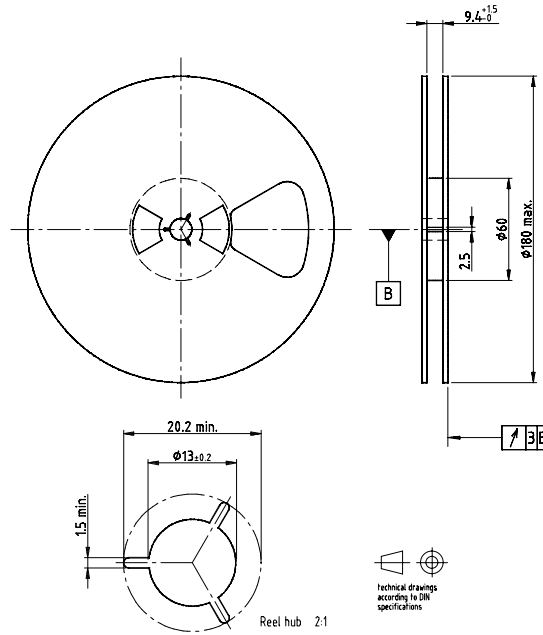
Proposed pad layout (for reference only)



Drawing-No.: 6.541-5069.01-4
Issue: 2; 24.11.14

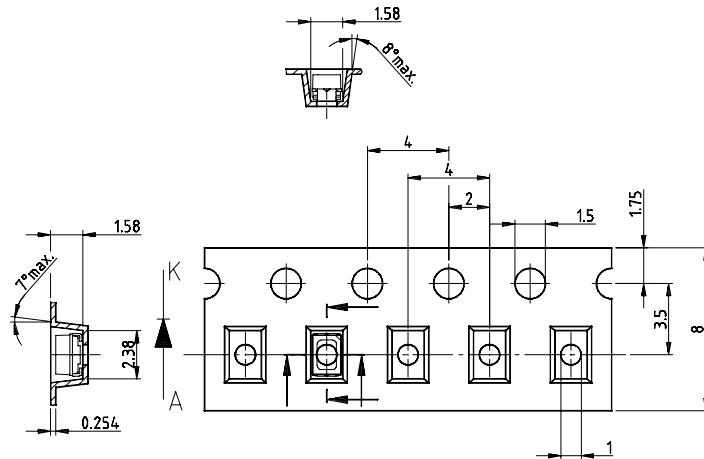


REEL DIMENSIONS in millimeters



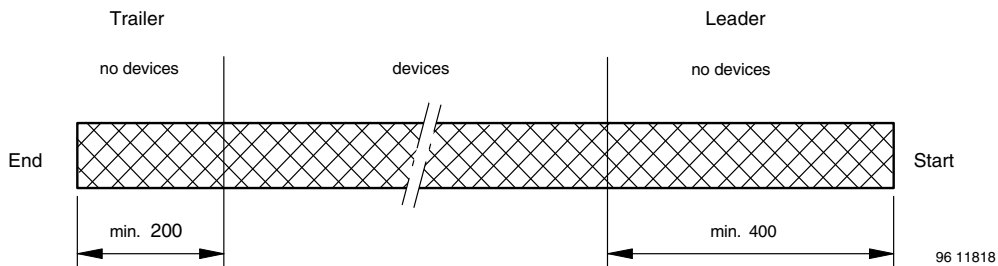
Drawing-No: 9.800-5051.V5-4
 Issue: 1, 25.07.02
 16938

TAPE DIMENSIONS in millimeters



Drawing-No: 9.700-5266.01-4
 Issue: 1, 05.06.02
 16939

LEADER AND TRAILER DIMENSIONS in millimeters



GS08 = 3000 pcs



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3
 0.1 N to 1.3 N
 300 mm/min ± 10 mm/min
 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by:	ACC	-
Packed by:	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company Logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

SOLDERING PROFILE

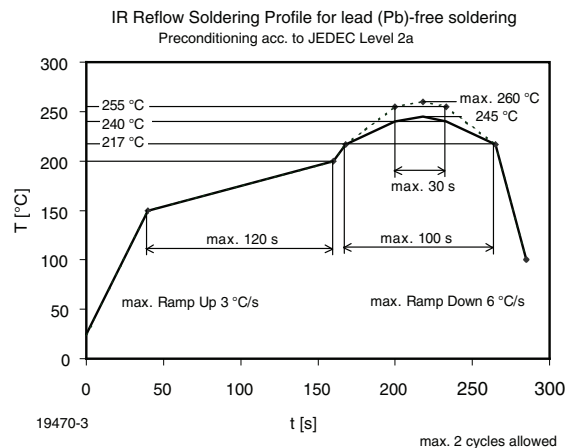
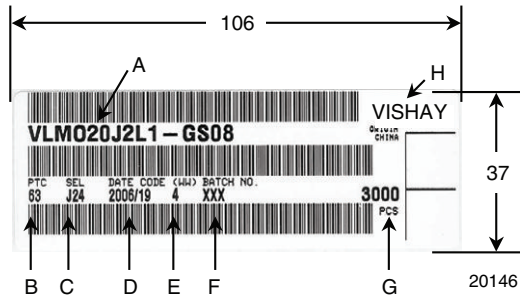


Fig. 12 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020)



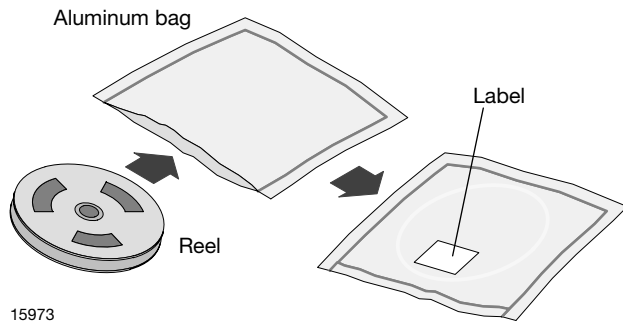
BAR CODE PRODUCT LABEL (example)



- A. Type of component
- B. Manufacturing plant
- C. SEL - selection code (bin):
e.g.: J2 = code for luminous intensity group
4 = code for color group
- D. Date code year / week
- E. Day code (e.g. 4: Thursday)
- F. Batch no.
- G. Total quantity
- H. Company code

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

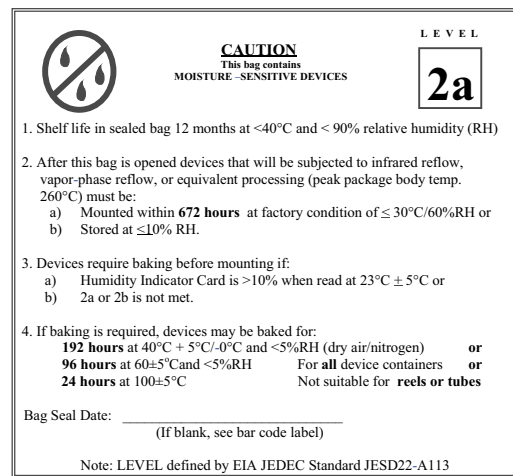
After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.



Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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